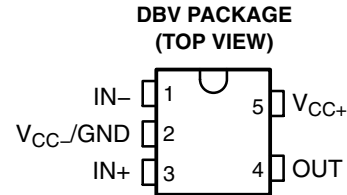


TLV1391 SINGLE DIFFERENTIAL COMPARATORS

SLCS128F – APRIL 1996 – REVISED JUNE 2007

- **Low-Voltage and Single-Supply Operation**
 $V_{CC} = 2\text{ V to }7\text{ V}$
- **Common-Mode Voltage Range Includes Ground**
- **Fast Response Time . . . 0.7 μs Typ**
- **Low Supply Current . . . 80 μA Typ and 150 μA Max**
- **Fully Specified at 3-V and 5-V Supply Voltages**



description/ordering informaton

The TLV1391 is a differential comparator built using a Texas Instruments low-voltage, high-speed bipolar process. These devices have been developed specifically for low-voltage, single-supply applications. Their enhanced performance makes them excellent replacements for the LM393 in the improved 3-V and 5-V system designs.

The TLV1391, with its typical supply current of only 80 μA , is ideal for low-power systems. Response time also has been improved to 0.7 μs .

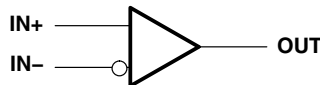
ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–0°C to 70°C	SOT-23-5 (DBV)	Reel of 3000	TLV1391CDBVR	Y3D_
		Reel of 250	TLV1391CDBVT	
–40°C to 85°C	SOT-23-5 (DBV)	Reel of 3000	TLV1391IDBVR	Y3E_
		Reel of 250	TLV1391IDBVT	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ The actual top-side marking has one additional character that designates the wafer fab/assembly site.

symbol (each comparator)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

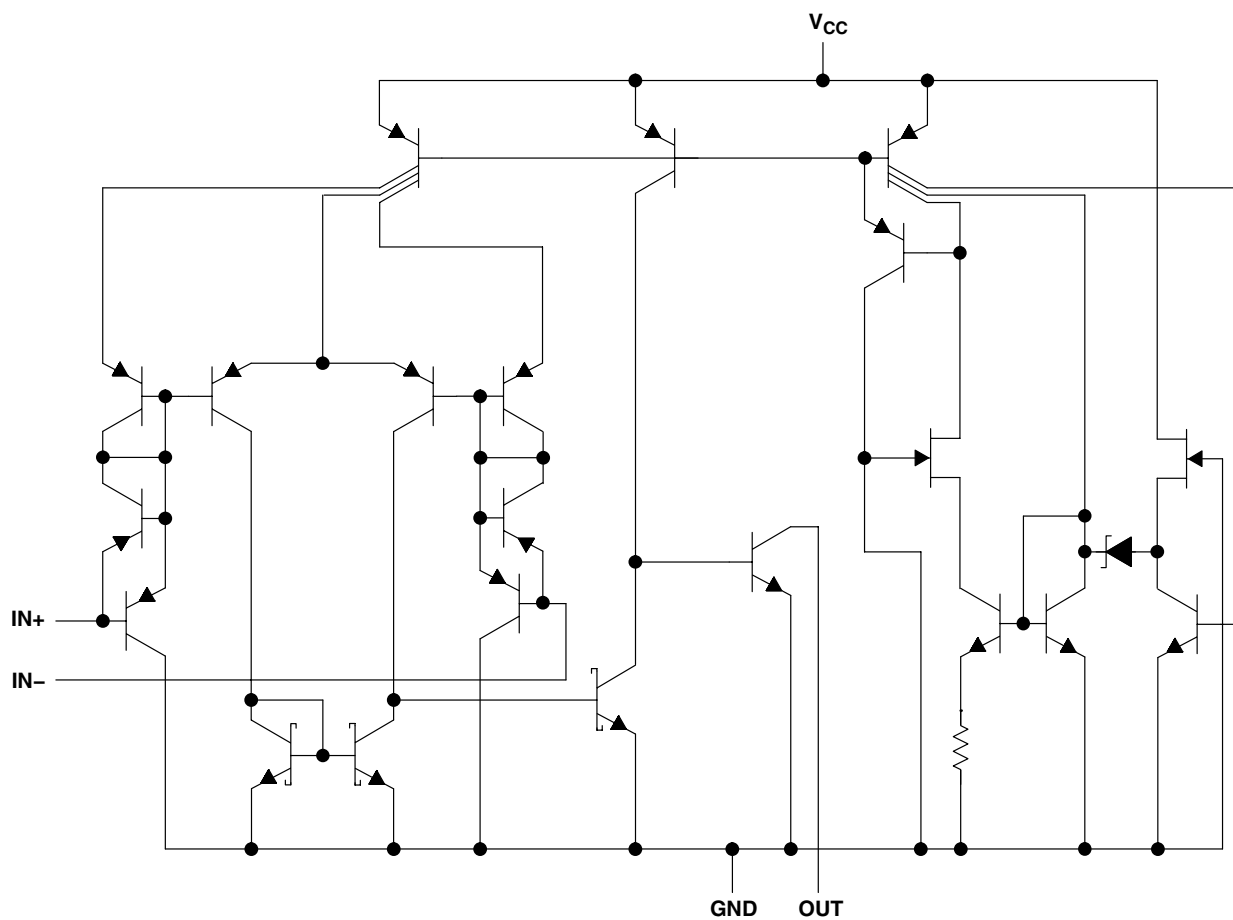
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TLV1391

SINGLE DIFFERENTIAL COMPARATORS

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equivalent schematic



COMPONENT COUNT	
Transistors	26
Resistors	1
Diodes	4
Epi-FET	1

TLV1391 SINGLE DIFFERENTIAL COMPARATORS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC} (see Note 1)	7 V
Differential input voltage, V_{ID} (see Note 2)	± 7 V
Input voltage range, V_I (any input)	-0.3 V to V_{CC}
Output voltage, V_O	7 V
Output current, I_O (each output)	20 mA
Duration of short-circuit current to GND (see Note 3)	Unlimited
Package thermal impedance, θ_{JA} (see Note 4 and 5)	206°C/W
Operating virtual junction temperature, T_J	150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T_{stg}	-65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to the network GND.
 2. Differential voltages are at the noninverting input with respect to the inverting input.
 3. Short circuits from the outputs to V_{CC} can cause excessive heating and eventual destruction of the chip.
 4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2	7	V
T _A	Operating free-air temperature	TLV1391C	0	70	°C
		TLV1391I	−40	85	



TLV1391

SINGLE DIFFERENTIAL COMPARATORS

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electrical characteristics, $V_{CC} = 3\text{ V}$

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
V_{IO} Input offset voltage	$V_O = 1.4\text{ V}$, $V_{IC} = V_{ICR}(\text{min})$	25°C		1.5	5	mV
		Full range			9	
V_{ICR} Common-mode input voltage range		25°C	0 to $V_{CC}-1.5$	0 to $V_{CC}-1.2$		V
		Full range	0 to $V_{CC}-2$			
V_{OL} Low-level output voltage	$V_{ID} = -1\text{ V}$, $I_{OL} = 500\text{ }\mu\text{A}$	Full range		120	300	mV
I_{IO} Input offset current	$V_O = 1.4\text{ V}$	25°C		5	50	nA
		Full range			150	
I_{IB} Input bias current	$V_O = 1.4\text{ V}$	25°C		-40	-250	nA
		Full range			-400	
I_{OH} High-level output current	$V_{ID} = 1\text{ V}$, $V_{OH} = 3\text{ V}$	25°C		0.1		nA
	$V_{ID} = 1\text{ V}$, $V_{OH} = 5\text{ V}$	Full range			100	
I_{OL} Low-level output current	$V_{ID} = -1\text{ V}$, $V_{OL} = 1.5\text{ V}$	25°C	500			μA
$I_{CC(H)}$ High-level supply current	$V_O = V_{OH}$	25°C		80	125	μA
		Full range			150	
$I_{CC(L)}$ Low-level supply current	$V_O = V_{OL}$	25°C		80	125	μA
		Full range			150	

switching characteristics, $V_{CC} = 3\text{ V}$, $C_L = 15\text{ pF}^\dagger$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
Response time	100-mV input step with 5-mV overdrive, $R_L = 5.1\text{ k}\Omega$	0.7	μs

[†] C_L includes the probe and jig capacitance.

TLV1391

SINGLE DIFFERENTIAL COMPARATORS

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electrical characteristics, $V_{CC} = 5\text{ V}$

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
V_{IO} Input offset voltage	$V_O = 1.4\text{ V}, V_{IC} = V_{ICR}(\text{min})$	25°C		1.5	5	mV
		Full range			9	
V_{ICR} Common-mode input voltage range		25°C	0 to $V_{CC}-1.5$	0 to $V_{CC}-1.2$		V
		Full range	0 to $V_{CC}-2$			
V_{OL} Low-level output voltage	$V_{ID} = -1\text{ V}, I_{OL} = 500\text{ }\mu\text{A}$	Full range		120	300	mV
I_{IO} Input offset current	$V_O = 1.4\text{ V}$	25°C		5	50	nA
		Full range			150	
I_{IB} Input bias current	$V_O = 1.4\text{ V}$	25°C		-40	-250	nA
		Full range			-400	
I_{OH} High-level output current	$V_{ID} = 1\text{ V}, V_{OH} = 3\text{ V}$	25°C		0.1		nA
	$V_{ID} = 1\text{ V}, V_{OH} = 5\text{ V}$	Full range			100	
I_{OL} Low-level output current	$V_{ID} = -1\text{ V}, V_{OL} = 1.5\text{ V}$	25°C	600			μA
$I_{CC(H)}$ High-level supply current	$V_O = V_{OH}$	25°C		100	150	μA
		Full range			175	
$I_{CC(L)}$ Low-level supply current	$V_O = V_{OL}$	25°C		100	150	μA
		Full range			175	

switching characteristics, $V_{CC} = 5\text{ V}, C_L = 15\text{ pF}^\dagger, T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
Response time	100-mV input step with 5-mV overdrive, $R_L = 5.1\text{ k}\Omega$	0.65	μs
	TTL-level input step, $R_L = 5.1\text{ k}\Omega$	0.18	

[†] C_L includes the probe and jig capacitance.



TLV1391

SINGLE DIFFERENTIAL COMPARATORS

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TYPICAL CHARACTERISTICS

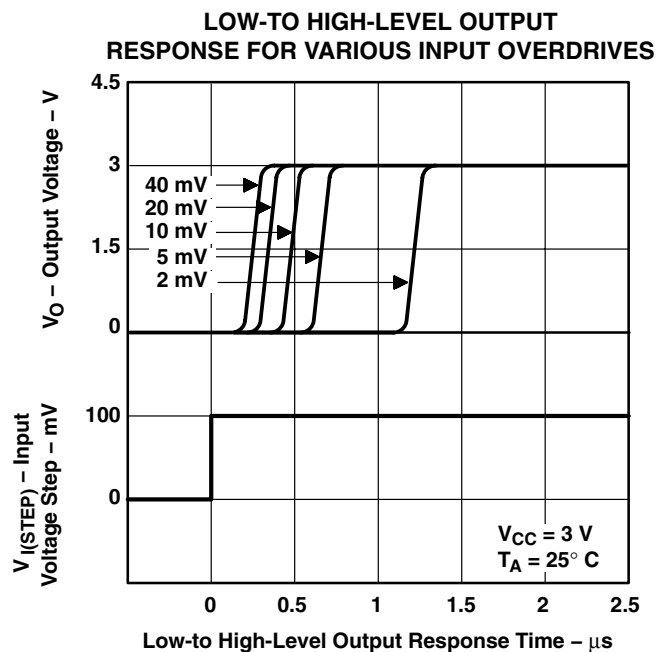


Figure 1

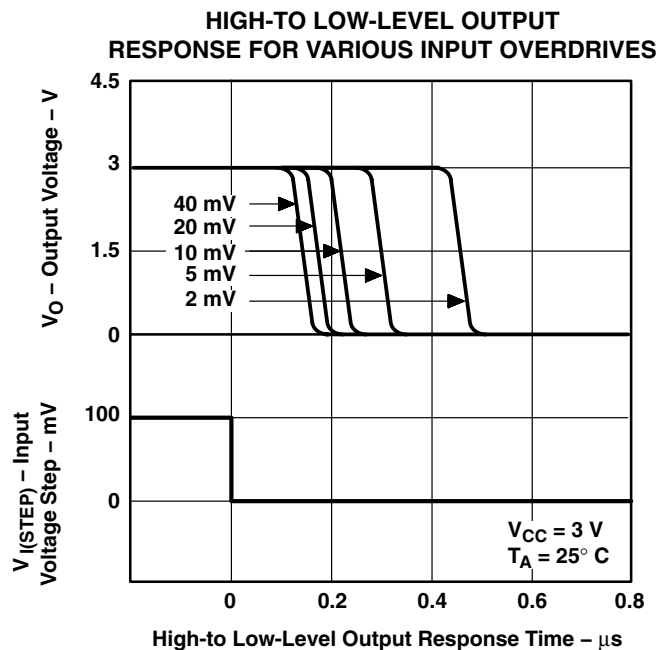


Figure 2

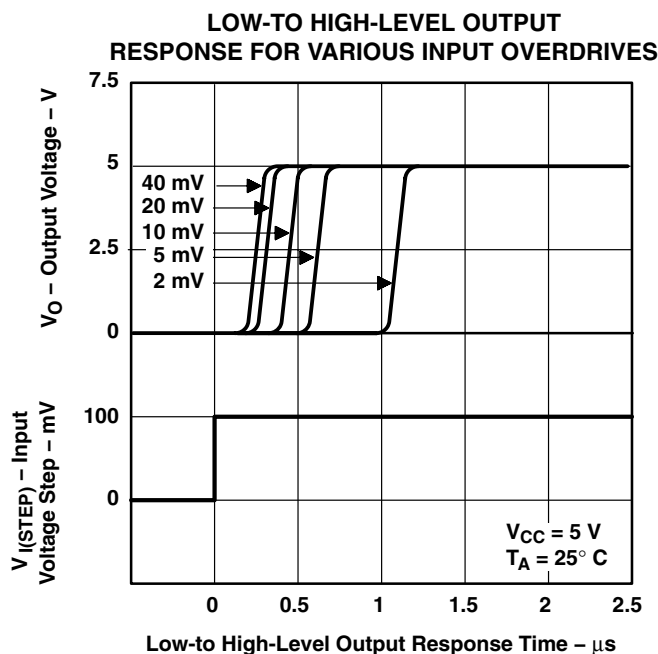


Figure 3

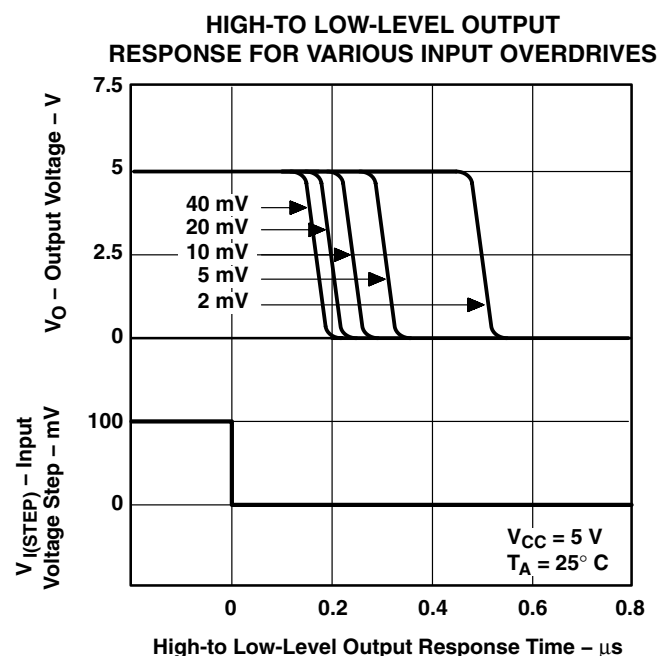


Figure 4

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TLV1391CDBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	0 to 70	(1391, Y3D6, Y3DG, Y3DJ)
TLV1391CDBVR.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	(1391, Y3D6, Y3DG, Y3DJ)
TLV1391CDBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(1391, Y3D6, Y3DG, Y3DJ)
TLV1391CDBVR1G4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	1391
TLV1391CDBVR1G4.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	1391
TLV1391CDBVRG4	Obsolete	Production	SOT-23 (DBV) 5	-	-	Call TI	Call TI	0 to 70	Y3DG
TLV1391IDBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 85	(1391, Y3E6, Y3EB, Y3EJ)
TLV1391IDBVR.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(1391, Y3E6, Y3EB, Y3EJ)
TLV1391IDBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	-	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(1391, Y3E6, Y3EB, Y3EJ)
TLV1391IDBVRG4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(1391, Y3E6, Y3EB)
TLV1391IDBVRG4.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(1391, Y3E6, Y3EB)

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV1391CDBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLV1391CDBVR1G4	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLV1391IDBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLV1391IDBVRG4	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV1391CDBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLV1391CDBVR1G4	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLV1391IDBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLV1391IDBVRG4	SOT-23	DBV	5	3000	210.0	185.0	35.0



SOT-23 - 1.45 mm max height

PIN 1 INDEX AREA

1 2 3 4 5

2X 0.95

1.9

3.0 2.6

1.75 1.45

B

A

3.05 2.75

(0.1)

(0.15)

1.9

5X 0.5 0.3

$\oplus$	0.2	$\odot$	C	A	B
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NOTE 5

4X 0°-15°

(1.1)

1.45 0.90

0.15 0.00 TYP

0.25

E PLANE

4X 4°-15°

0.22 0.08 TYP

0.6 0.3 TYP

SEATING PLANE

NOTES:

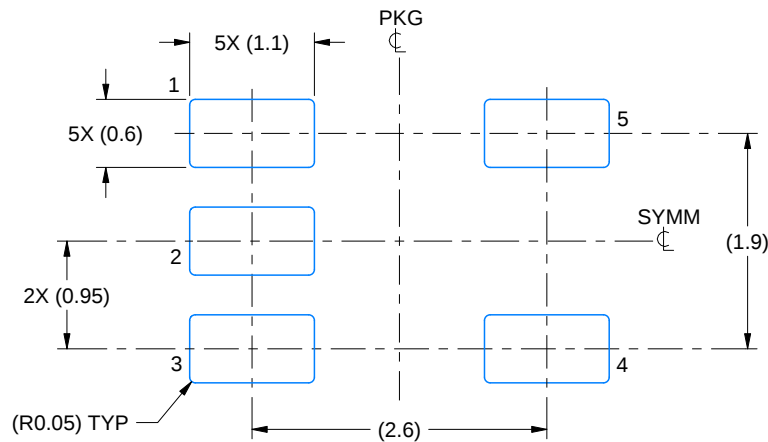
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

EXAMPLE BOARD LAYOUT

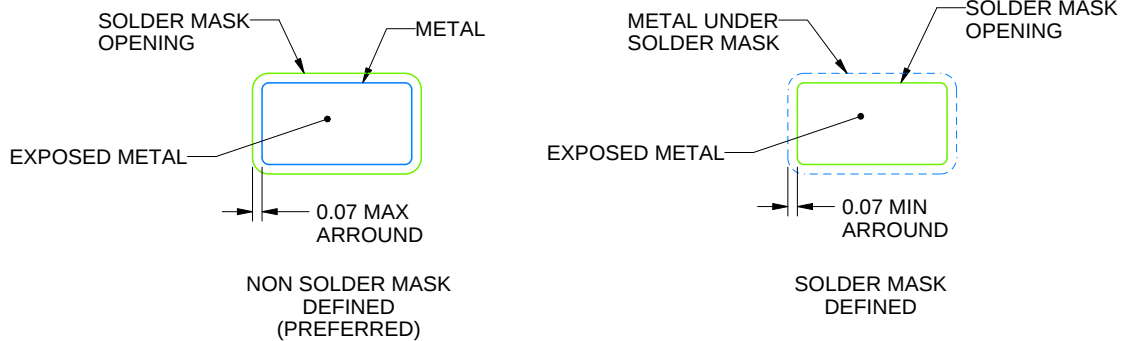
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

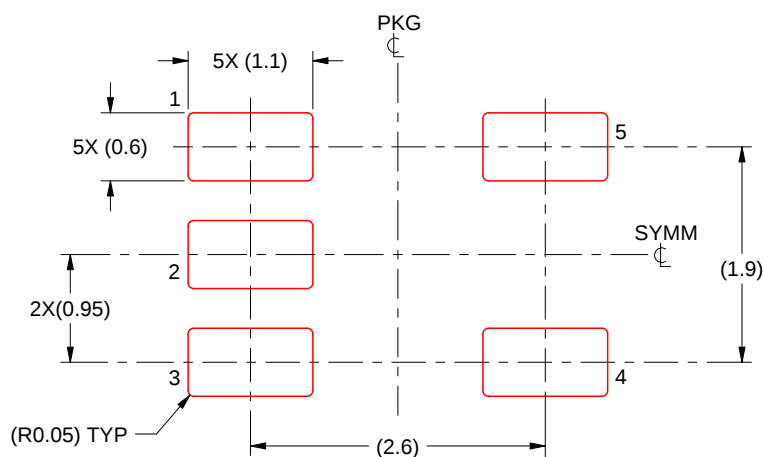
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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